IPC - ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1					Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No. Homogeneous Mater					ials and Mfg Information				
upplier Inform	ation														
Company name*			Company unique ID			J	Unique ID Authority					Response Date*			
nsemi											2025-05-11				
Contact Name			Title - Contact			I	Phone - Contact*				Email - Contact*				
Product-Env-Stewa	rds		Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com				
uthorized Represer	ntative*	Title - Representative			I	Phone - Representative*				Email - Representative*					
Product-Env-Stewa	rds	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com					
Requester	Requester Item Number Mfr Ite		tem Number Mfr Item Name					Version	ı	Manufacturing Site		Weight*	UOM	Unit Type	
		MGSF1N02LT1G NFET St		NFET SOT23 20V	NFET SOT23 20V 75MA 90MO		2025-05-11		(CN1		3.13	mg	Each	
	Process Informatio		orminal Pasa	Alloy	STD-020 MSL	Dating	Dook Proc	age Pody	Camparatu	May Time at Dook	Tomporet	ura Numb	per of Reflow Cyc	Jac	
			Terminal Base Alloy J-STD-CU Alloy 1		21D-070 M2F	_ Kaung	Peak Process Body Temper 260 C						ber of Keriow Cyc	nes	
•	i (Sii) - anneaied	C	U Alloy	1			200		Ic	30	secon	18 3			
omments	me at neels termos	duning sel	domina ia 10 °	20 seconds											
	me at peak temperature														
: more informatio	on regarding material co	mposition p	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.16	mg	Supplier	Silicon (Si)	7440-21-3		0.16	mg
Lead Frame	2.92		Supplier	Silver (Ag)	7440-22-4		0.5198	mg
			В	Nickel (Ni)	7440-02-0		0.9023	mg
			Supplier	Iron (Fe)	7439-89-6		1.2468	mg
			Supplier	Copper (Cu)	7440-50-8		0.2511	mg
Mold Compound-Black	4.9		Supplier	Boron zinc hydroxide oxide	138265-88-0		0.147	mg
			Supplier	Zinc Monoxide (ZnO)	1314-13-2		0.0245	mg
			Supplier	2,4,6-triamino-s-triazincompd.withs-triazine-triol	37640-57-6		0.147	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		3.92	mg
			Supplier	Carbon Black (C)	1333-86-4		0.049	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		0.392	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.2205	mg
Plating	0.14	mg	Supplier	Tin (Sn)	7440-31-5		0.14	mg
Wire Bond - Cu	0.01	mg	Supplier	Copper (Cu)	7440-50-8		0.01	mg